

## Application Brief

# Accuracy Comparison of Isolated Shunt and Closed-Loop Current Sensing



Alex Smith

### Introduction

Several industrial and automotive applications such as [on board chargers](#), [solar inverters](#), [DC charging \(pile\) stations](#), [power conversion systems](#), and [motor drives](#) require isolation to protect the digital circuitry from the high-voltage circuit performing a measurement. Two ways to accomplish the isolated current sensing for these applications are isolated shunt based sensing and magnetic (Hall or flux-gate) based sensing. This document compares Texas Instruments [AMC3302](#) a single-supply, [isolated amplifier](#) to a popular closed-loop current sensor (CLCS).

### Technologies Overview

Isolated shunt based current sensing relies on measuring a voltage across a precise in-line resistor, known as a shunt resistor.



Figure 1. Isolated Shunt Based Current Sensing

The shunt resistance must be very accurate in order to produce the expected voltage for the supplied current, as any variation in expected resistance will contribute directly to a gain error. The benefit of shunt based current sensing is that it allows for industry leading accuracy, immunity to magnetic interference, scalability and small size.

CLCS uses a magnetic core to sense the magnetic field created by the current passing through the primary conductor. The magnetic field sensing element included in the CLCS is used to provide a compensation current that is applied to the magnetic core. This compensation current creates a flux that is equal in magnitude, but in the opposite direction of the

flux created by the primary conductor; producing a zero-flux measurement. Magnetic based current sensing is vulnerable to magnetic interference which can affect the offset and linearity performance of the device.

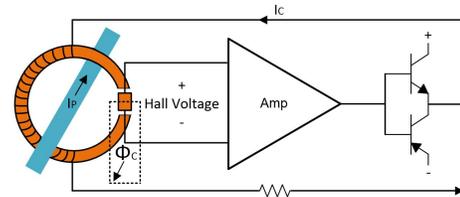


Figure 2. Hall Based Closed-Loop Sensor

Additional information comparing the two technologies can be found [here](#).

### Test Setup

A test setup was created in order to directly compare the performance of these two technologies. A DC current source, electronic load and digital multi-meters were used to capture data for a +/-85A primary current sweep at three different temperatures; -40C, 25C and 85C. All measurements were automated according to IEEE488.

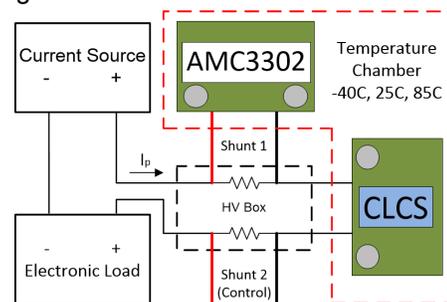
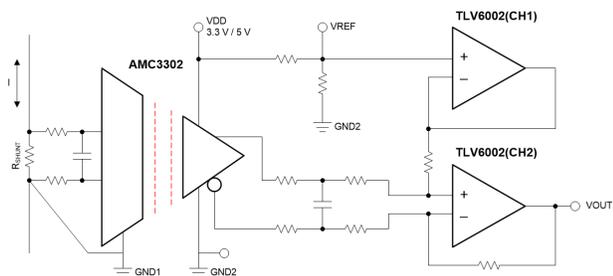


Figure 3. AMC3302 Circuit and CLCS Test Setup Block Diagram

Please note that the  $500\mu\Omega$  Shunt 1 used for the AMC3302 circuit measurement and  $500\mu\Omega$  Shunt 2 used for the control measurement were not subjected to changes in ambient temperature, therefore the shunt temperature drift error is not included in this analysis.

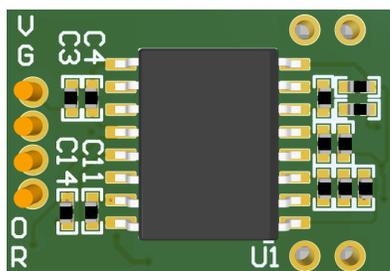
Both shunts are rated for  $\pm 0.25\%$  tolerance,  $\pm 15\text{ppm}/^\circ\text{C}$  temperature coefficient and 20W power dissipation.

The circuit diagram below shows the **AMC3302** and **TLV6002** circuit used for the accuracy comparison. Channel 1 of the TLV6002 was used to buffer a reference voltage generated via resistor divider while the differential output of the AMC3302 was converted from differential to single-ended via channel 2. Thus the AMC3302 circuit has an identical interface as the CLCS; VDD, GND, VREF and VOUT.



**Figure 4. AMC3302 Circuit Diagram**

Below is the AMC3302 Printed Circuit Board (PCB). The PCB was designed such that the AMC3302 circuit fits within the same x, y footprint as the CLCS, 13.4mm x 21.9mm. The AMC3302 PCB is much smaller in terms of height; 2.6mm compared to 16mm for the CLCS, a reduction in height of 84%.

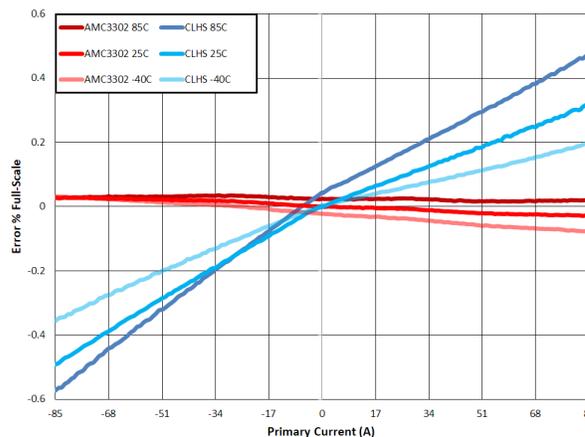


**Figure 5. AMC3302 Circuit Printed Circuit Board**

### Accuracy Comparison

Figure 6. shows the accuracy results for the  $\pm 85\text{A}$  primary current sweep over temperature in terms of error as a percentage of full-scale output after a 25C offset calibration. The AMC3302 circuit results are shown in shades of red and the CLCS in blue. The AMC3302 circuit is very accurate over the full current and temperature range without gain calibration, better than 0.1%. The CLCS shows worse gain error drift and linearity performance compared to the AMC3302 circuit, resulting in an overall error greater than 0.5%. The AMC3302 circuit offers an accuracy improvement

of more than 5x compared to the CLCS over the full current and temperature range.



**Figure 6. Accuracy Comparison for AMC3302 Circuit and Closed-loop Current Sensor After Offset Calibration**

Below shows an accuracy comparison table of absolute maximum error.

Temperature	-40C	25C	85C
AMC3302 Circuit	-0.077%	-0.029%	0.035%
CLCS	-0.356%	-0.492%	-0.573%

### Conclusion

The table below summarizes the comparison of the AMC3302 circuit and the CLCS. For systems requiring industry leading accuracy, the AMC3302 circuit shows a clear advantage compared to the CLCS. The size of the AMC3302 circuit used for this comparison is equal size in terms of x and y dimensions, while showing a clear advantage in terms of height, z. The AMC3302 circuit also offers immunity to magnetic interference, as well as scalability.

	AMC3302 Circuit	CLCS
Accuracy	++	+
Size	+	-
Magnetic Immunity	++	--
Scalability	++	-
Ease of Design	+	++

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